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Vishay Semiconductors

## Thyristor High Voltage, Phase Control SCR, 40 A



PRIMARY CHARACTERISTICS							
I <sub>T(AV)</sub> 25 A							
V <sub>DRM</sub> /V <sub>RRM</sub>	1200 V						
V <sub>TM</sub>	1.6 V						
I <sub>GT</sub>	35 mA						
T <sub>J</sub>	-40 °C to 140 °C						
Package	3L TO-220AB						
Circuit configuration	Single SCR						

#### **FEATURES**

- Designed and qualified according to JEDEC®-JESD 47
- 140 °C max. operating junction temperature
- Material categorization: for definitions of compliance please see www.vishav.com/doc?99912



#### **APPLICATIONS**

 Typical usage is in input rectification crowbar (soft start) and AC switch in motor control, UPS, welding, and battery charge

#### **DESCRIPTION**

The VS-40TTS12... high voltage series of silicon controlled rectifiers are specifically designed for medium power switching and phase control applications. The glass passivation technology used has reliable operation up to 140 °C junction temperature.

MAJOR RATINGS AND CHARACTERISTICS									
PARAMETER	TEST CONDITIONS	VALUES	UNITS						
I <sub>T(AV)</sub>	Sinusoidal waveform	25	Δ.						
I <sub>RMS</sub>		40	A						
V <sub>RRM</sub> /V <sub>DRM</sub>		1200	V						
I <sub>TSM</sub>		350	A						
V <sub>T</sub>	T <sub>J</sub> = 25 °C	1.6	V						
dV/dt		500	V/µs						
dl/dt		150	A/μs						
T <sub>J</sub>		-40 to +140	°C						

VOLTAGE RATINGS									
PART NUMBER	V <sub>RRM</sub> , MAXIMUM PEAK REVERSE VOLTAGE V	V <sub>DRM</sub> , MAXIMUM PEAK DIRECT VOLTAGE V	°C L <sup>1</sup>						
VS-40TTS12-M3	1200	1200	-25 to +140						



ABSOLUTE MAXIMUM RATINGS							
PARAMETER	SYMBOL	TEST CO	VALUES	UNITS			
Maximum average on-state current	I <sub>T(AV)</sub>	T <sub>C</sub> = 93 °C, 180° conduc	tion half sine wave	25			
Maximum RMS on-state current	I <sub>RMS</sub>			40	_		
Maximum peak, one-cycle	-	10 ms sine pulse, rated \	/ <sub>RRM</sub> applied	300	Α		
non-repetitive surge current	I <sub>TSM</sub>	10 ms sine pulse, no vol	tage reapplied	350			
Maying up 12t for fusion	I <sup>2</sup> t	10 ms sine pulse, rated \	/ <sub>RRM</sub> applied	450	A <sup>2</sup> s		
Maximum I <sup>2</sup> t for fusing	1-1	10 ms sine pulse, no vol	630	A-S			
Maximum I <sup>2</sup> √t for fusing	I <sup>2</sup> √t	t = 0.1 to 10 ms, no volta	6300	A²√s			
Maximum on-state voltage	V <sub>TM</sub>	80 A, T <sub>J</sub> = 25 °C		1.6	V		
Low level value of on-state slope resistance	r <sub>t</sub>	T 140 %C		11.4	mΩ		
Low level value of threshold voltage	V <sub>T(TO)</sub>	T <sub>J</sub> = 140 °C		0.96	V		
Maximum reverse and direct leakage	1 /1	T <sub>J</sub> = 25 °C	V Datad V A/	0.5			
current	$I_{RRM}/I_{DRM}$	T <sub>J</sub> = 140 °C	$V_R$ = Rated $V_{RRM}/V_{DRM}$	12			
Holding current	I <sub>H</sub>	Anode supply = 6 V, resistive load, initial $I_T$ = 1 A, $T_J$ = 25 °C		100	mA		
Maximum latching current	ΙL	Anode supply = 6 V, resi	200				
Maximum rate of rise of off-state voltage	dV/dt	$T_J = T_J \text{ max., linear to } 80$	500	V/µs			
Maximum rate of rise of turned-on current	dl/dt		•	150	A/µs		

TRIGGERING								
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS				
Maximum peak gate power	$P_{GM}$		8.0	W				
Maximum average gate power	P <sub>G(AV)</sub>		2.0	VV				
Maximum peak positive gate current	+ I <sub>GM</sub>		1.5	А				
Maximum peak negative gate voltage	- V <sub>GM</sub>		10	V				
Maximum required DC gate current to trigger	I <sub>GT</sub>	Anode supply = 6 V, resistive load, T <sub>J</sub> = 25 °C	35	mA				
Maximum required DC gate voltage to trigger	V <sub>GT</sub>	Anode supply = 6 V, resistive load, T <sub>J</sub> = 25 °C	1.3	V				
Maximum DC gate voltage not to trigger	$V_{GD}$	T = 140 °C V = Poted value	0.2					
Maximum DC gate current not to trigger	I <sub>GD</sub>	T <sub>J</sub> = 140 °C, V <sub>DRM</sub> = Rated value	1.5	mA				

SWITCHING								
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS				
Typical turn-on time	t <sub>gt</sub>	T <sub>J</sub> = 25 °C	0.9					
Typical reverse recovery time	t <sub>rr</sub>	T <sub>.1</sub> = 140 °C	4	μs				
Typical turn-off time	t <sub>q</sub>	1 IJ = 140 C	110					

THERMAL AND MECHANICAL SPECIFICATIONS							
PARAMETER		SYMBOL	TEST CONDITIONS	VALUES	UNITS		
Maximum junction and storage temperature range		T <sub>J</sub> , T <sub>Stg</sub>		-40 to 140	°C		
Maximum thermal resistance, junction to case		$R_{\text{thJC}}$	DC operation	0.8			
Maximum thermal resistance, junction to ambient		R <sub>thJA</sub>		60	°C/W		
Typical thermal resistance, case to heatsink		R <sub>thCS</sub>	Mounting surface, smooth and greased	0.5			
Approximate weight				2	g		
Approximate weight				0.07	OZ.		
Mounting torque	minimum			6 (5)	kgf · cm		
woulding torque	maximum			12 (10)	(lbf · in)		
Marking device			Case style 3L TO-220AB	40T	ΓS12		

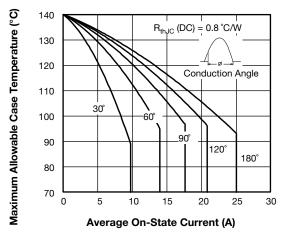


Fig. 1 - Current Rating Characteristics

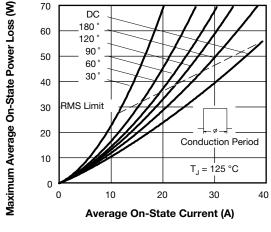


Fig. 4 - On-State Power Loss Characteristics

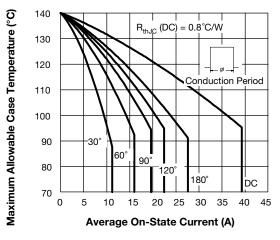


Fig. 2 - Current Rating Characteristics

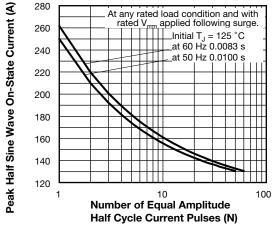


Fig. 5 - Maximum Non-Repetitive Surge Current

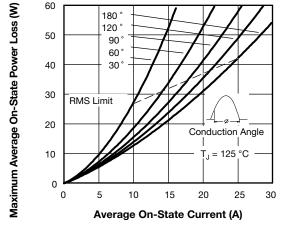


Fig. 3 - On-State Power Loss Characteristics

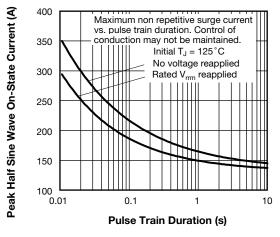


Fig. 6 - Maximum Non-Repetitive Surge Current



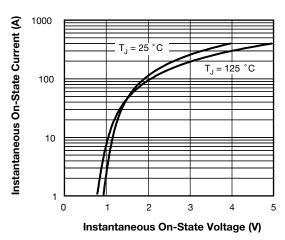


Fig. 7 - On-State Voltage Drop Characteristics

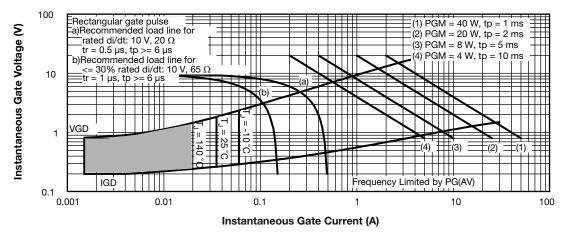


Fig. 8 - Gate Characteristics

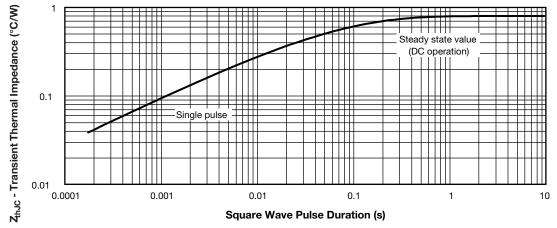
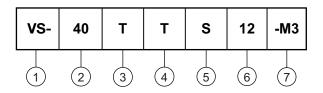


Fig. 9 - Thermal Impedance  $Z_{thJC}$  Characteristics



### **ORDERING INFORMATION TABLE**

**Device code** 



1 - Vishay Semiconductors product

2 - Current rating, RMS value

3 - Circuit configuration:

T = single thyristor

4 - Package:

T = TO-220

5 - Type of silicon:

S = standard recovery rectifier

6 - Voltage rating (12 = 1200 V)

7 - Environmental digit:

-M3 = halogen-free, RoHS-compliant, and terminations lead (Pb)-free

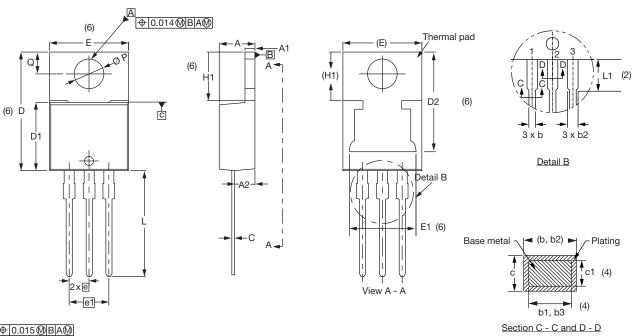
ORDERING INFORMATION (Example)								
PREFERRED P/N	QUANTITY PER T/R	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION					
VS-40TTS12-M3	50	1000	Antistatic plastic tubes					

LINKS TO RELATED DOCUMENTS	
Dimensions	www.vishay.com/doc?96154
Part marking information	www.vishay.com/doc?95028

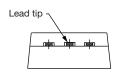


### **3L TO-220AB**

### **DIMENSIONS** in millimeters and inches



#### **⊕** 0.015 **M** B A **M**



Conforms to JEDEC® outline TO-220AB

SYMBOL	MILLIM	IETERS	INC	HES	NOTES	NOTES	SYMBOL	MILLIN	IETERS	INC	HES	NOTES
STWIBOL	MIN.	MAX.	MIN.	MAX.	NOTES		STWIBOL	MIN.	MAX.	MIN.	MAX.	NOTES
Α	4.25	4.65	0.167	0.183			D2	11.68	13.30	0.460	0.524	6, 7
A1	1.14	1.40	0.045	0.055			E	10.11	10.51	0.398	0.414	3, 6
A2	2.50	2.92	0.098	0.115			E1	6.86	8.89	0.270	0.350	6
b	0.69	1.01	0.027	0.040			е	2.41	2.67	0.095	0.105	
b1	0.38	0.97	0.015	0.038	4		e1	4.88	5.28	0.192	0.208	
b2	1.20	1.73	0.047	0.068			H1	6.09	6.48	0.240	0.255	6
b3	1.14	1.73	0.045	0.068	4		L	13.52	14.02	0.532	0.552	
С	0.36	0.61	0.014	0.024			L1	3.32	3.82	0.131	0.150	2
c1	0.36	0.56	0.014	0.022	4		ØΡ	3.54	3.91	0.139	0.154	
D	14.85	15.35	0.585	0.604	3		Q	2.60	3.00	0.102	0.118	
D1	8.38	9.02	0.330	0.355		1		•			•	

### **Notes**

- <sup>(1)</sup> Dimensioning and tolerancing as per ASME Y14.5M-1994
- (2) Lead dimension and finish uncontrolled in L1
- (3) Dimension D, D1, and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- (4) Dimension b1, b3, and c1 apply to base metal only
- Controlling dimensions: inches
- (6) Thermal pad contour optional within dimensions E, H1, D2, and E1
- (7) Outline conforms to JEDEC® TO-220, except D2



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